



Transponder coil 2.36 mH

Size: 11.4 × 3.5 × 2.4 (mm)

Series/Type:	High-Q Transponder coil 11mm
Ordering code:	B82450H2364A000
Date:	September 2010
Version:	01

Rated inductance: 2.36 mH
Sensitivity: 30 mV/μT



Construction

- Ferrite core
- Winding: enamel copper wire welded to terminals
- Flame-retardant molding

Features

- Robust construction for a high mechanical stability when exposed to shock, drop and bending tests
- High sensitivity
- High Quality Factor
- Qualified to AEC-Q200
- Suitable for pick and place and AOI (Automatic Optical Inspection)
- Suitable for lead-free reflow soldering as referenced in JEDEC J-STD 020C
- RoHS-compatible

Applications

- Car access systems
 - immobilizer
 - PEPS (Passive Entry, Passive Start)
- TPMS (Tire Pressure Monitoring Systems)

Terminals

- Base material CuSn6
- Layer composition Ni, Sn Electro-plated

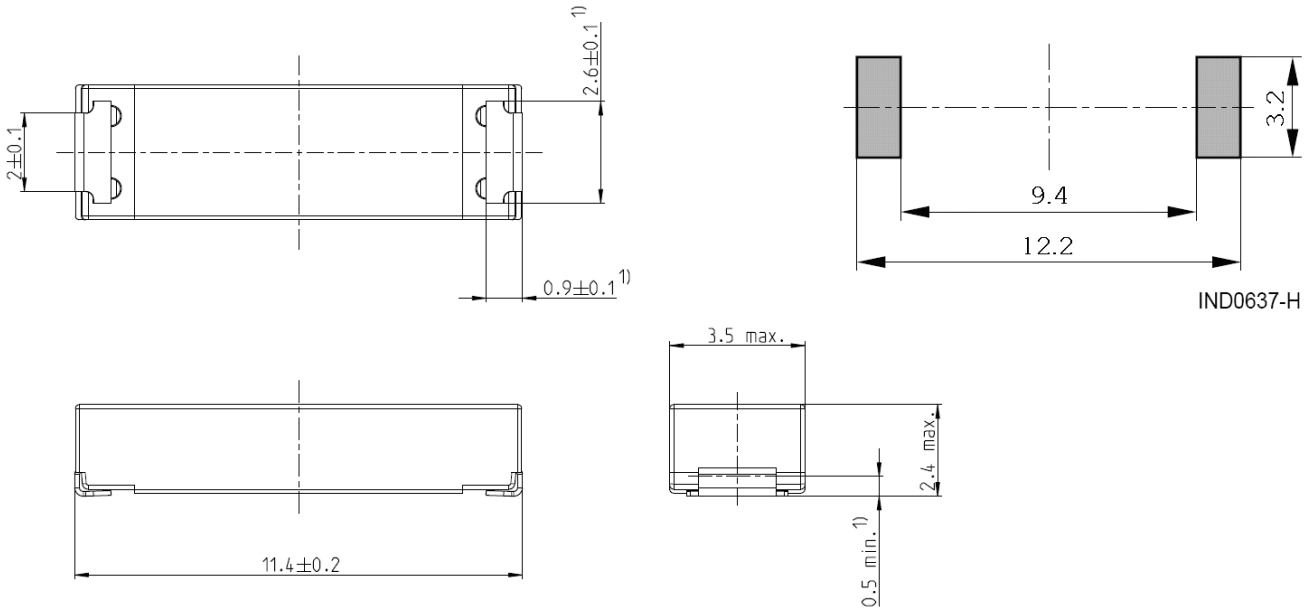
Marking

- Marking on component:
 - Manufacturer, L-value (nH, coded), letter "A", date of manufacture (YWWDD), last five digits of lot number, internal information
- Minimum data on reel:
 - Manufacturer, ordering code, L value, quantity, date of packing

Delivery mode and packing unit

- 24 mm blister tape, wound on 330 mm Ø reel
- Packing unit: 2500 pcs./reel

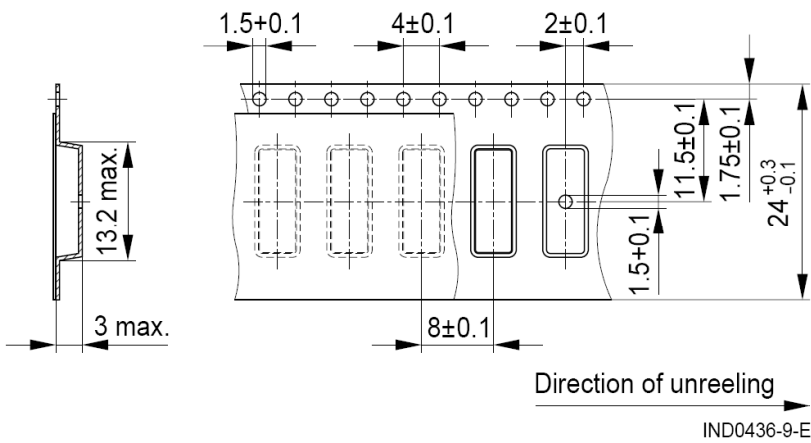
Dimensional drawing and layout recommendation



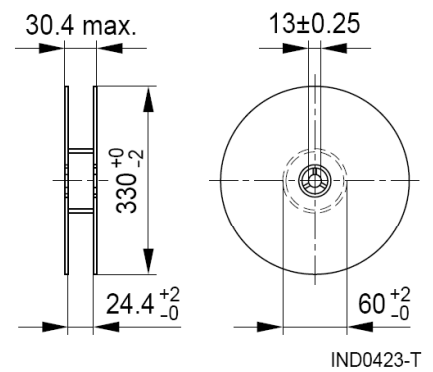
1) Soldering area

Taping and packing

Blister tape



Reel



Dimensions in mm

Technical data and measuring conditions

Rated inductance L_R	Measured with Agilent 4294A and test fixture Agilent 16034 at frequency f_L , RMS voltage 500mV, 20 °C
Q factor Q_{min}	Measured with Agilent 4294A and test fixture Agilent 16034 at frequency f_Q , RMS voltage 500mV, 20 °C
Sensitivity S_{typ}	Measured with Helmholtz coil test setup at 125kHz
Resonance frequency f_{res}	Measuring with network analyzer Agilent 8753D, 20 °C
DC resistance R_{max}	Measured at 20 °C
Solderability (lead-free)	Sn95.5Ag3.8Cu0.7: (245±5) °C, 3s wetting of soldering area ≥ 90% (based on IEC 60068-2-58)
Resistance to soldering heat	260 °C, 40 s (as referenced in JEDEC J-STD 020C)
Climatic category	40/125/56 (to IEC 60068-1)
Storage conditions	Mounted: -40 °C...+125 °C Packaged: -25 °C...+40 °C, ≤ 75% RH
Weight	Approx. 0.32 g

Characteristics and ordering codes

L_R	L	f_L, f_Q	Q_{min}	S_{typ}	R_{max}	F_{res}	Ordering code
[mH]	tolerance	[kHz]		$\left[\frac{mV}{\mu T} \right]$	[Ω]	[MHz]	
2.36	±3%	125	55	30	25	>2.0	B82450H2364A000

Cautions and warnings

- Please note the recommendations in our data book (latest edition) and in the data sheets.
 - Particular attention should be paid to the derating curves given there.
 - The soldering conditions should also be observed. Temperatures quoted in relation to wave soldering refer to the pin, not the housing
- If the components are to be washed varnished it is necessary to check whether the washing varnish agent that is used has a negative effect on the wire insulation, any plastics that are used, or glued on joints. In particular, it is possible for washing varnish agent residues to have a negative effect in the long-term on wire insulation.
- The following points must be observed if the components are potted in customer applications:
 - Many potting materials shrink as they harden. They therefore exert a pressure on the plastic housing or core. This pressure can have a deleterious effect on electrical properties, and in extreme cases can damage the core or plastic housing mechanically.
 - It is necessary to check whether the potting material used attacks or destroys the wire insulation, plastics or glue.
 - The effect of the potting material can change the high-frequency behaviour of the components.
- Ferrites are sensitive to direct impact. This can cause the core material to flake, or lead to breakage of the core.
- Even for customer-specific products, conclusive validation of the component in the circuit can only be carried out by the customer

Important notes

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